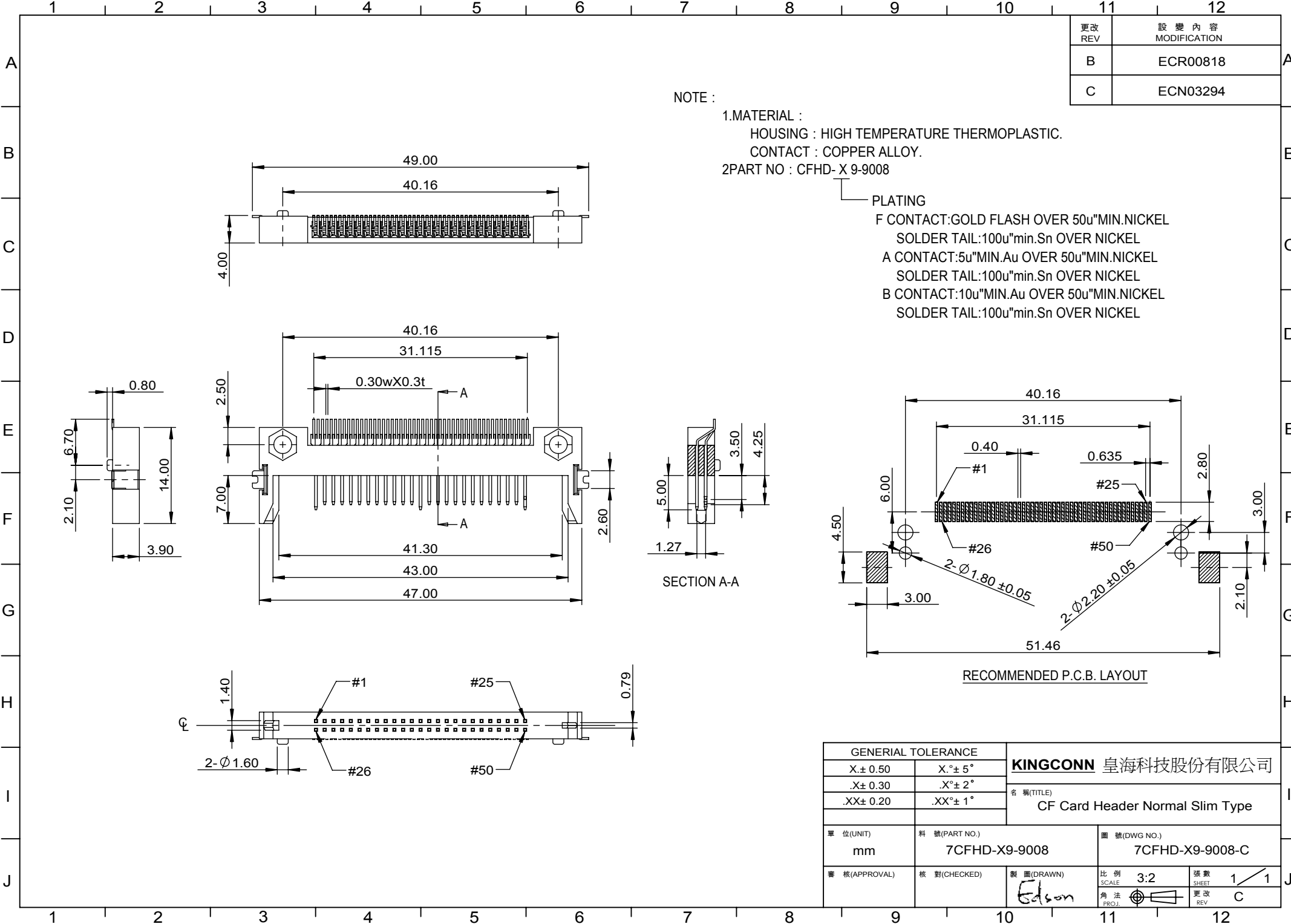
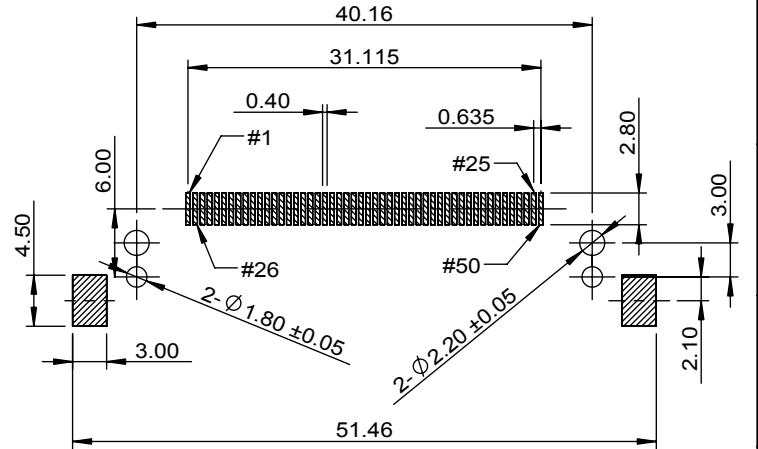




更改 REV	設 變 內 容 MODIFICATION
B	ECR00818
C	ECN03294

NOTE :

- 1.MATERIAL :
HOUSING : HIGH TEMPERATURE THERMOPLASTIC.
CONTACT : COPPER ALLOY.
2PART NO : CFHD- X 9-9008
- PLATING
F CONTACT:GOLD FLASH OVER 50u"MIN.NICKEL
SOLDER TAIL:100u"min.Sn OVER NICKEL
A CONTACT:5u"MIN.Au OVER 50u"MIN.NICKEL
SOLDER TAIL:100u"min.Sn OVER NICKEL
B CONTACT:10u"MIN.Au OVER 50u"MIN.NICKEL
SOLDER TAIL:100u"min.Sn OVER NICKEL



RECOMMENDED P.C.B. LAYOUT

GENERAL TOLERANCE		KINGCONN 皇海科技股份有限公司	
X± 0.50	X°± 5°		
.X± 0.30	.X°± 2°		
.XX± 0.20	.XX°± 1°		
		名 稱(TITLE) CF Card Header Normal Slim Type	
單 位(UNIT) mm	料 號(PART NO.) 7CFHD-X9-9008	圖 號(DWG NO.) 7CFHD-X9-9008-C	
審 核(APPROVAL)	核 對(CHECKED)	製 圖(DRAWN) Edson	比 例 3:2 SCALE 角 法 PROJ.
		張 數 1/1 SHEET 更 改 REV C	